



CKG Series Mega Cap Type Capacitors

Type:

Issue date:

CKG32K CKG45K CKG57K CKG45N CKG57N

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Version A11

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MULTILAYER CERAMIC CHIP CAPACITORS



CKG Series

Mega Cap Type Capacitors Туре: СКG32К, СКG45К, СКG57К, СКG45N, СКG57N

Features



No polarity

- Twice the capacitance is obtainable on a single capacitor space
 Unique construction provides high reliability
 The metal caps absorb stress from thermal and
- Ine metal caps absorb stress from thermal and mechanical shocks, ensuring excellent performance on aluminum circuit substrates

• Low ESR and ESL promise excellent characteristics for high frequency switching power supply

Structure



No. Name	Material
1 Dielectric	BaTiO ₃
② Electrode	Ni
3 (4) Termination	Cu
(4) Termination	Ni-Sn

High Temp Solder

42 Alloy

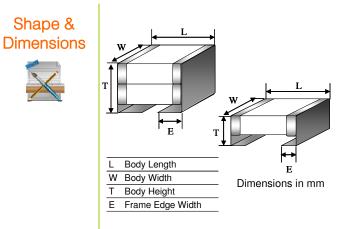
Applications



- Smoothing circuits
- Temperature variable applications

OVE

- Maintenance free power supplies
- DC to DC converters
- · Automotive applications





Part Number Construction

5

6

			CKGS
s	Series Name		
	Case Code	Length	Width
	CKG32K	3.60 ± 0.30	2.60 ± 0.30
	CKG45K	5.00 ± 0.50	3.50 ± 0.50
	CKG57K	6.00 ± 0.50	5.00 ± 0.50
	CKG45N	5.00 ± 0.50	3.50 ± 0.50
	CKG57N	6.00 ± 0.50	5.00 ± 0.50
Т	emperature C	haracteristic -	
	Temperature	Capacitance	Temperature

Metal Cap Joint

Metal Cap

Temperature Characteristics Capacitance Change Temperature Range X5R ±15% -55 to +85°C X7R ±15% -55 to +125°C X7S ±22% -55 to +125°C

Rated Voltage (DC)

Voltage Code	Voltage(DC)
1C	16V
1E	25V
1H	50V
2A	100V
2E	250V
2J	630V

	CKG32K	<u>X7R</u>	<u>1E</u>	<u>106</u>	Μ	Ţ	<u>XXXX</u>
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Internal Codes	
 Packaging Style	
Packaging Code	Style
Т	Tape and Reel
 Capacitance Tole	rance
Tolerance Code	Tolerance
М	± 20%
 Nominal Capacita	ance (pF)
and in units of pi second digits ide figures of the cap	is expressed in three digit codes co Farads (pF). The first and ntify the first and second significant pacitance. The third digit identifies designates a decimal point.
Capacitance Code	Capacitance
0R5	0.5pF
010	1pF
102	1,000pF (1nF)

102	1,000pF (1nF)
105	1,000,000pF (1µF)

MULTILAYER CERAMIC CHIP CAPACITORS



CKG32K [Single Stack]

Capacitance Range Chart

Temperature Characteristics: X7R (± 15%), X7S (± 22), X5R (± 15%) Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

	Con				X7R	X7S						
	Code			Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1H (50V)	
47,000	473	M: ± 20%										
100,000	104											
220,000	224											
470,000	474											
1,000,000	105								Standard Thickness			
4,700,000	475											
10,000,000	106								3.35 ± 0.10 mm			



Capacitance Range Table

Class 2 (Temperature Stable)

Temperature Characteristics: X7R (± 15%), X7S (± 22)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
CKG32KX7R2J473M	X7R	630V	47,000	± 20%	3.35 ± 0.10
CKG32KX7R2E104M	X7R	250V	100,000	± 20%	3.35 ± 0.10
CKG32KX7R2E224M	X7R	250V	220,000	± 20%	3.35 ± 0.10
CKG32KX7R2A474M	X7R	100V	470,000	± 20%	3.35 ± 0.10
CKG32KX7R2A105M	X7R	100V	1,000,000	± 20%	3.35 ± 0.10
CKG32KX7R1H105M	X7R	50V	1,000,000	± 20%	3.35 ± 0.10
CKG32KX7R1E475M	X7R	25V	4,700,000	± 20%	3.35 ± 0.10
CKG32KX7R1E106M	X7R	25V	10,000,000	± 20%	3.35 ± 0.10
CKG32KX7S1H106M	X7S	50V	10,000,000	± 20%	3.35 ± 0.10

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MULTILAYER CERAMIC CHIP CAPACITORS



CKG45K [Single Stack]

Capacitance Range Chart

Temperature Characteristics: X7R (± 15%), X7S (± 22) Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

Consolitores	Can		X7R							
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)	2A (100V)	
100,000	104	M: ± 20%								
220,000	224									
470,000	474									
1,000,000	105									
2,200,000	225									
3,300,000	335									
4,700,000	475									Standard Thickness
10,000,000	106									
22,000,000	226									2.90 ± 0.10 mm



Capacitance Range Table

Class 2 (Temperature Stable)

Temperature Characteristics: X7R (± 15%), X7S (± 22)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
CKG45KX7R2J104M	X7R	630V	100,000	± 20%	2.90 ± 0.10
CKG45KX7R2E224M	X7R	250V	220,000	± 20%	2.90 ± 0.10
CKG45KX7R2E474M	X7R	250V	470,000	± 20%	2.90 ± 0.10
CKG45KX7R2A105M	X7R	100V	1,000,000	± 20%	2.90 ± 0.10
CKG45KX7R2A225M	X7R	100V	2,200,000	± 20%	2.90 ± 0.10
CKG45KX7R1H335M	X7R	50V	3,300,000	± 20%	2.90 ± 0.10
CKG45KX7R1H475M	X7R	50V	4,700,000	± 20%	2.90 ± 0.10
CKG45KX7R1E475M	X7R	25V	4,700,000	± 20%	2.90 ± 0.10
CKG45KX7S2A475M	X7S	100V	4,700,000	± 20%	2.90 ± 0.10
CKG45KX7R1C106M	X7R	16V	10,000,000	± 20%	2.90 ± 0.10
CKG45KX7R1C226M	X7R	16V	22,000,000	± 20%	2.90 ± 0.10

MULTILAYER CERAMIC CHIP CAPACITORS



CKG57K [Single Stack]

Capacitance Range Chart

Temperature Characteristics: X7R (± 15%), X7S (± 22) Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

Canaaitanaa	Can				X	7R			X7S	
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)	2A (100V)	
220,000	224	M: ± 20%								
470,000	474									
1,000,000	105									
2,200,000	225									
3,300,000	335									
4,700,000	475									
10,000,000	106									
22,000,000	226									Standard Thickness
47,000,000	476]								3.35 ± 0.15 mm



Capacitance Range Table

Class 2 (Temperature Stable)

Temperature Characteristics: X7R (± 15%), X7S (± 22)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
CKG57KX7R2J224M	X7R	630V	220,000	± 20%	3.35 ± 0.15
CKG57KX7R2E474M	X7R	250V	470,000	± 20%	3.35 ± 0.15
CKG57KX7R2A105M	X7R	100V	1,000,000	± 20%	3.35 ± 0.15
CKG57KX7R2E105M	X7R	250V	1,000,000	± 20%	3.35 ± 0.15
CKG57KX7R2A225M	X7R	100V	2,200,000	± 20%	3.35 ± 0.15
CKG57KX7R2A335M	X7R	100V	3,300,000	± 20%	3.35 ± 0.15
CKG57KX7R2A475M	X7R	100V	4,700,000	± 20%	3.35 ± 0.15
CKG57KX7R1H475M	X7R	50V	4,700,000	± 20%	3.35 ± 0.15
CKG57KX7S2A106M	X7S	100V	10,000,000	± 20%	3.35 ± 0.15
CKG57KX7R1E106M	X7R	25V	10,000,000	± 20%	3.35 ± 0.15
CKG57KX7R1H106M	X7R	50V	10,000,000	± 20%	3.35 ± 0.15
CKG57KX7R1E226M	X7R	25V	22,000,000	± 20%	3.35 ± 0.15
CKG57KX7R1C476M	X7R	16V	47,000,000	± 20%	3.35 ± 0.15

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MULTILAYER CERAMIC CHIP CAPACITORS



CKG45N [Double Stack]

Capacitance Range Chart

Temperature Characteristics: X7R (± 15%), X7S (± 22), X5R (± 15%) Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

Canacitanaa	0.00				X	7R			X7S	X	5R
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)	2A (100V)	1H (50V)	1C (16V)
220,000	224	M: ± 20%									
470,000	474										
1,000,000	105]									
2,200,000	225]									
3,300,000	335]									
4,700,000	475]									
6,800,000	685]									
10,000,000	106]									
22,000,000	226										
47,000,000	476]									
Standard Thick	kness	5.00 ±	0.50 mm								



Capacitance Range Table

Class 2 (Temperature Stable)

Temperature Characteristics: X7R (± 15%), X7S (± 22), X5R (± 15%)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
CKG45NX7R2J224M	X7R	630V	220,000	± 20%	5.00 ± 0.50
CKG45NX7R2E474M	X7R	250V	470,000	± 20%	5.00 ± 0.50
CKG45NX7R2E105M	X7R	250V	1,000,000	± 20%	5.00 ± 0.50
CKG45NX7R2A225M	X7R	100V	2,200,000	± 20%	5.00 ± 0.50
CKG45NX7R1H335M	X7R	50V	3,300,000	± 20%	5.00 ± 0.50
CKG45NX7R2A475M	X7R	100V	4,700,000	± 20%	5.00 ± 0.50
CKG45NX7R1H685M	X7R	50V	6,800,000	± 20%	5.00 ± 0.50
CKG45NX7S2A106M	X7S	100V	10,000,000	± 20%	5.00 ± 0.50
CKG45NX7R1E106M	X7R	25V	10,000,000	± 20%	5.00 ± 0.50
CKG45NX5R1H106M	X5R	50V	10,000,000	± 20%	5.00 ± 0.50
CKG45NX7R1C226M	X7R	16V	22,000,000	± 20%	5.00 ± 0.50
CKG45NX5R1C476M	X5R	16V	47,000,000	± 20%	5.00 ± 0.50

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CERAMIC CF



CKG57N [Double Stack]

Capacitance Range Chart

Temperature Characteristics: X7R (± 15%), X7S (± 22), X5R (± 15%) Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

Consolitones	Con				X	7R			X7S		X5R	
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)
470,000	474	M: ± 20%										
1,000,000	105											
2,200,000	225											
4,700,000	475											
10,000,000	106											
22,000,000	226											
33,000,000	336											
47,000,000	476											
100,000,000	107											

Thickness 5.00 ± 0.50 mm



Capacitance **Range Table**

Class 2 (Temperature Stable)

Temperature Characteristics: X7R (± 15%), X7S (± 22), X5R (± 15%)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
CKG57NX7R2J474M	X7R	630V	470,000	± 20%	5.00 ± 0.50
CKG57NX7R2E105M	X7R	250V	1,000,000	± 20%	5.00 ± 0.50
CKG57NX7R2A225M	X7R	100V	2,200,000	± 20%	5.00 ± 0.50
CKG57NX7R2E225M	X7R	250V	2,200,000	± 20%	5.00 ± 0.50
CKG57NX7R2A475M	X7R	100V	4,700,000	± 20%	5.00 ± 0.50
CKG57NX7R2A106M	X7R	100V	10,000,000	± 20%	5.00 ± 0.50
CKG57NX7R1H106M	X7R	50V	10,000,000	± 20%	5.00 ± 0.50
CKG57NX7S2A226M	X7S	100V	22,000,000	± 20%	5.00 ± 0.50
CKG57NX7R1E226M	X7R	25V	22,000,000	± 20%	5.00 ± 0.50
CKG57NX5R1H226M	X5R	50V	22,000,000	± 20%	5.00 ± 0.50
CKG57NX7R1C336M	X7R	16V	33,000,000	± 20%	5.00 ± 0.50
CKG57NX5R1E476M	X5R	25V	47,000,000	± 20%	5.00 ± 0.50
CKG57NX5R1C107M	X5R	16V	100.000.000	± 20%	5.00 ± 0.50

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MULTILAYER CERAMIC CHIP CAPACITORS



CKG Series – Mega Cap Type Capacitors

No.	ltem	Performance	Test or Inspection Method			
1	External Appearance	No defects which may affect performance.	Inspect with magnifying glass (3 $ imes$).			
2	Insulation Resistance	500M $\Omega \bullet \mu$ F min. (As for the capacitors of rated voltage 16V DC, 100M $\Omega \bullet \mu$ F min.), whichever smaller.	Apply rated voltage for 60s. As for the rated voltage 630V DC, apply 500V DC.			
3	Voltage Proof	Withstand test voltage without insulation breakdown or other damage.	Rated VoltageApply voltage100V and under2.5 × rated voltageOver 100V1.5 × rated voltageAbove DC voltage shall be applied for 1 to 5s.Charge / discharge current shall not exceed 50mA.			
4	Capacitance	Within the specified tolerance.	Rated CapacitanceMeasuring FrequencyMeasuring voltage10uF and under1kHz±10%1.0±0.2VrmsOver 10uF120Hz±20%0.5±0.2 Vrms			
5	Dissipation Factor (Class 2)	T.C.D.F.X5R0.045 max.X7R0.045 max.X7S0.075 max.X7T0.010 max.	See No.4 in this table for measuring condition.			
6	Temperature Characteristics of Capacitance	No Voltage Applied X5R: ± 15% X7R: ± 15% X7S: ± 22% X7T: + 22/-33%	Capacitance shall be measured by the steps shown in the following table after thermal equilibrium is obtained for each step. $\Delta C \text{ be calculated ref. STEP3 reading}$ $\boxed{\begin{array}{c c} Step & Temperature (^{\circ}C) \\\hline 1 & Reference temp. \pm 2 \\\hline 2 & Min. operating temp. \pm 2 \\\hline 3 & Reference temp. \pm 2 \\\hline 4 & Max. operating temp. \pm 2 \\\hline \end{array}}$			
7	Robustness of Terminations	No sign of termination coming off, breakage of ceramic, or other abnormal signs.	Reflow solder the capacitors on P.C. board (shown in Appendix 1) and apply a pushing force of 5N with $10\pm1s$.			

MULTILAYER CERAMIC CHIP CAPACITORS



CKG Series – Mega Cap Type Capacitors

No.	ltem	Performance		Test o	r Inspection Method			
8	Bending	No mechanical damage.		Reflow solder the capacitor on P.C. board (shown in Appendix 2) and bend it for 1mm.				
				<u>N</u>	50 F R230	<pre> 2</pre>		
9	Solderability	shall be covered w		Reflow : Append	solder the capacitors on P.C ix 1).	board (shown in		
			ng with no more than	Solder:	H63A (JIS Z 3282)			
		a small amount of scattered imperfections such as pinholes or un-		Flux:	Isopropyl alcohol (JIS K 88	39)		
		wetted or de-wette	ed areas.		Rosin (JIS K 5902) 25% solid solution.			
		These imperfectio concentrated in or						
10	Temperature Cy			Reflow	solder the capacitors on P.C	board (shown ii		
				Appendix 1) before testing. Expose the capacitors in the condition step1 through				
	External appearance	No mechanical da	image.					
	Capacitance				and repeat 100 times consec			
	Capacitanice	Characteristics	Change from the value before test		he capacitors in ambient cor neasurement.	ndition for $24\pm 2h$		
		X5R X7R		Step	Temperature (ºC)	Time (min.)		
		X7S	± 7.5 %	1	Min. operating temp. ±3	30 ± 3		
		X7T		2	Reference Temp. ±2	2-5		
	D.F.	Meet the initial spe	ec.	3	Max. operating temp. ± 2	30 ± 2		
				- 4	Reference Temp. ± 2	2 - 5		
	Insulation	Meet the initial spe	ec.					
	Resistance							

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MULTILAYER CERAMIC CHIP CAPACITORS



CKG Series – Mega Cap Type Capacitors

No.	ltem	Performance		Test or Inspection Method		
14	Moisture Resista			Reflow solder the capacitors on a P.C. board (shown in Appendix 1) before testing.		
	External appearance			Apply the rated voltage at temperature $40\pm2^{\circ}$ C and 90 — to 95%RH for 500+24,0h.		
	Capacitance			Charge/discharge current shall not exceed 50mA.		
	X5R X7R ± 12.5 %		+ 10.5 %	Leave the capacitor in ambient conditions for 24±2h before measurement.		
		X7S X7T	± 12.5 %	Voltage conditioning: Voltage treats the capacitor under testing temperature		
	D.F. (Class 2) Characteristics			and voltage for 1 hour.		
		X5R/X7R/X7S/X7T: 200% of initial spec. max.		Leave the capacitor in ambient conditions for 24±2h before measurement. Use this measurement for initial value.		
	Insulation $25M \Omega \cdot \mu$ F min.					
	Resistance	(As for the capacit 16V DC, $5M \Omega \bullet \mu$	tors of rated voltage F min.).			
15	Life			Reflow solder the capacitors on a P.C. Board shown in Appendix 1 before testing.		
	External appearance	No mechanical da	image.	Below the voltage shall be applied at Maximum		
	Capacitance	Characteristics	Change from the value before test	 operating temperature ±2°C for 1,000 +48, 0h. Applied voltage is 1xRV. Some items may be tested at 		
		X5R		higher voltage (1.2x, 1.5x or 2x RV).		
		X7R X7S	± 15 %	Charge/discharge current shall not exceed 50mA.		
		X7T		Leave the capacitors in ambient condition for 24±2h before measurement.		
	D.F. (Class 2)	Characteristics		Voltage conditioning:		
		X5R/X7R/X7S/X7T: 200% of initial spec. max.		Voltage treat the capacitors under testing temperature and voltage for 1 hour.		
	Insulation Resistance	50M $\Omega \bullet \mu$ F min.	tors of rated voltage	Leave the capacitors in ambient condition for 24±2h before measurement.		
	RESISIONCE	16V DC, 10M $\Omega \bullet \mu$		Use this measurement for initial value.		

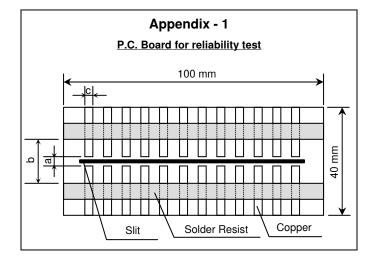
*As for the initial measurement of capacitors on number 6 and 10, leave capacitors at 150–10, 0°C for 1 hour and measure the value after leaving capacitors for 24±2h in ambient condition.

MULTILAYER CERAMIC CHIP CAPACITORS



General Specifications

CKG Series – Mega Cap Type Capacitors

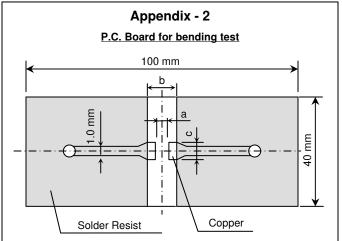


Material: Glass Epoxy (As per JIS C6484 GE4)

P.C. Board thickness: 1.6mm



Copper (thickness 0.035mm) Solder resist



Series	Dimensions (mm)				
Series	а	b	С		
CKG32K	2.2	5.0	2.9		
CKG45K	3.5	6.1	2.9		
CKG57K	4.1	7.6	4.7		
CKG45N	3.5	6.1	2.9		
CKG57N	4.1	7.6	4.7		

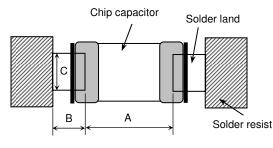
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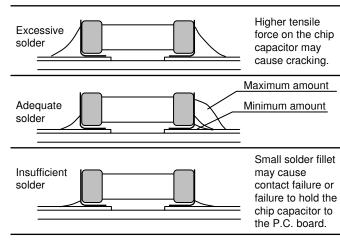
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Recommended Soldering Land Pattern

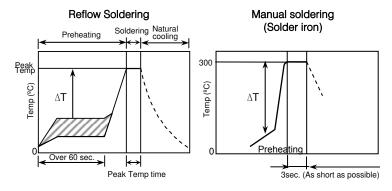


Reflow Solde	Unit: mm			
Туре	CKG32K	CKG45K	CKG57K	
Symbol	CRG52R	CKG45N	CKG57N	
А	2.0 ~ 2.2	3.3 ~ 3.7	3.9 ~ 4.3	
В	1.1 ~ 1.3	1.2 ~ 1.5	1.5 ~ 2.0	
С	2.3 ~ 2.5	2.7 ~ 3.2	4.5 ~ 5.0	

Recommended Solder Amount



Recommended Soldering Profile



Recommended soldering duration

Temp./	Reflow Soldering				
Dura. Solder	Peak temp (°C)	Duration (sec.)			
Sn-Pb Solder	230 max.	20 max.			
Lead-Free Solder	250 max.	10 max.			

Recommended solder compositions Sn-37Pb (Sn-Pb solder) Sn-3.0Ag-0.5Cu (Lead Free Solder)

Preheating Condition

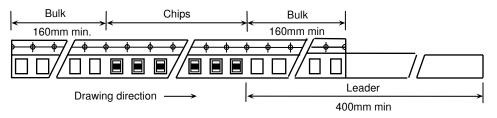
Soldering Method	Temperature (ºC)
Reflow soldering	∆T ≤ 130
Manual soldering	∆T ≤ 130

MULTILAYER CERAMIC CHIP CAPACITORS

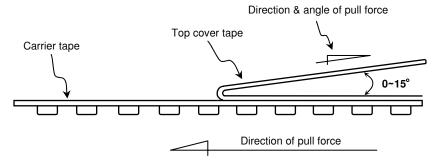


CKG Series – Mega Cap Type Capacitors

Carrier Tape Configuration



• Peel Back Force (Top Tape)



· Chip Quantity Per Reel and Structure of Reel

Pitch hole Cavity (Chip insert) Plastic carrier tape

Series	Taping	Chip quantity (pcs.)				
Series	Material	φ178mm (7") reel	φ330mm (13") reel			
CKG32K		1,000	4,000			
CKG45K						
CKG57K	Plastic		1.000			
CKG45N		-	1,000			
CKG57N						

• Carrier tape shall be flexible enough to be wound around a minimum radius of 30mm with components in tape.

- \bullet The missing of components shall be less than 0.1%
- Components shall not stick to the cover tape.
- The cover tape shall not protrude beyond the edges of the carrier tape and shall not cover the sprocket holes.

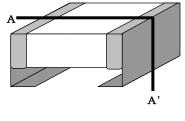
All specifications are subject to change without notice. Please read the precautions before using the product.
 US Catalog // CKG Series – Mega Cap Type // Version A11

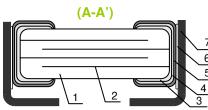
MULTILAYER CERAMIC CHIP CAPACITORS



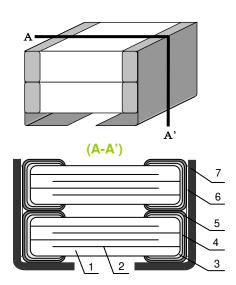
CKG Series – Mega Cap Type Capacitors

Inside Structure & Material System

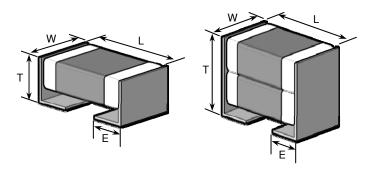




No.	NAME	MATERIAL		
		Class 1	Class 2	
(1)	Ceramic Dielectric	CaZrO ₃	BaTiO₃	
(2)	Internal Electrode	Nickel (Ni)		
(3)		Coppe	er (Cu)	
(4)	Termination	Nickel (Ni)		
(5)		Tin (Sn)		
(6)	Metal Cap Joint	High Temp Solger		
(7)	Metal Cap	42 Alloy		



Shape & Dimensions



Case Code			Dimensions (mm)				
Series	JIS	EIA	L	W	Т	Е	
CKCM25	C1310	CC0504	1.37	1.00	0.66 max	0.26 min.	
					0.90 max		
CKCL22	C2012	CC0805	2.00	1.25	0.85	0.35 min.	
CKCL44	C2012	CC0805	2.00	1.25	0.85	0.15 min.	
CKCA43	C3216	CC1206	3.20	1.60	1.00	0.30 min.	

• Environmental Information

TDK Corporation established internal product environmental assurance standards that include the six hazardous substances banned by the EU RoHS Directive¹ enforced on July 1, 2006 along with additional substances independently banned by TDK and has successfully completed making general purpose electronic components conform to the RoHS Directive².

- Abbreviation for Restriction on Hazardous Substances, which refers to the regulation EU Directive 2002/95/EC on hazardous substances by the European Union (EU) effective from July 1, 2006. The Directive bans the use of six specific hazardous substances in electric and electronic devices and products handled within the EU. The six substances are lead, mercury, cadmium, hexavalent chromium, PBB (polybrominated biphenyls), and PBDE (polybrominated diphenyl ethers).
- This means that, in conformity with the EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- For REACH (SVHC : 15 substances according to ECHA / October 2008) : All TDK MLCC do not contain these 15 substances.
- For European Directive 2000/53/CE and 2005/673/CE : Cadmium, Hexavalent Chromium, Mercury, Lead are not contained in all TDK MLCC.
- For European Directive 2003/11/CE : Pentabromodiphenyl-ether, Octabromodiphenyl-ether are not contained in all TDK MLCC.